



SamHop Microelectronics Corp.

**STF620S**

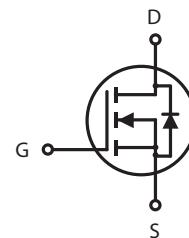
Ver 1.0

N-Channel Enhancement Mode Field Effect Transistor

| PRODUCT SUMMARY | | |
|------------------|----------------|-----------------------------|
| V _{DSS} | I _D | R _{DSON} (mΩ) Max |
| 60V | 12A | 75 @ V _{GS} =10V |
| | | 105 @ V _{GS} =4.5V |

FEATURES

- Super high dense cell design for low R_{DSON}.
- Rugged and reliable.
- TO-220F Package.

STF SERIES
TO-220F

ABSOLUTE MAXIMUM RATINGS (T_C=25°C unless otherwise noted)

| Symbol | Parameter | Limit | Units |
|-----------------------------------|--|----------------------|-------|
| V _{DS} | Drain-Source Voltage | 60 | V |
| V _{GS} | Gate-Source Voltage | ±20 | V |
| I _D | Drain Current-Continuous ^a | T _C =25°C | A |
| | | T _C =70°C | A |
| I _{DM} | -Pulsed ^b | 36 | A |
| E _{AS} | Avalanche Energy ^d | 30 | mJ |
| P _D | Maximum Power Dissipation ^a | T _C =25°C | W |
| | | T _C =70°C | W |
| T _J , T _{STG} | Operating Junction and Storage Temperature Range | -55 to 150 | °C |

THERMAL CHARACTERISTICS

| | | | |
|-------------------|--|----|------|
| R _θ JC | Thermal Resistance, Junction-to-Case ^a | 6 | °C/W |
| R _θ JA | Thermal Resistance, Junction-to-Ambient ^a | 65 | °C/W |

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ELECTRICAL CHARACTERISTICS ($T_A=25^\circ C$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|--|---|--|-----|------|------|-------|
| OFF CHARACTERISTICS | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V , I _D =250uA | 60 | | | V |
| I _{DS} | Zero Gate Voltage Drain Current | V _{DS} =48V , V _{GS} =0V | | | 1 | uA |
| I _{GSS} | Gate-Body Leakage Current | V _{GS} = ±20V , V _{DS} =0V | | | ±100 | nA |
| ON CHARACTERISTICS | | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =250uA | 1 | 2 | 3 | V |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =10V , I _D =6A | | 62 | 75 | m ohm |
| | | V _{GS} =4.5V , I _D =5A | | 80 | 105 | m ohm |
| g _{FS} | Forward Transconductance | V _{DS} =5V , I _D =6A | | 14.8 | | S |
| DYNAMIC CHARACTERISTICS ^c | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} =20V, V _{GS} =0V f=1.0MHz | | 982 | | pF |
| C _{oss} | Output Capacitance | | | 57 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 46 | | pF |
| SWITCHING CHARACTERISTICS ^c | | | | | | |
| t _{D(ON)} | Turn-On Delay Time | V _{DD} =30V I _D =1A V _{GS} =10V R _{GEN} = 6 ohm | | 19 | | ns |
| t _r | Rise Time | | | 13.4 | | ns |
| t _{D(OFF)} | Turn-Off Delay Time | | | 21.4 | | ns |
| t _f | Fall Time | | | 17.3 | | ns |
| Q _g | Total Gate Charge | V _{DS} =30V, I _D =6A, V _{GS} =10V | | 16 | | nC |
| | | V _{DS} =30V, I _D =6A, V _{GS} =4.5V | | 7.6 | | nC |
| Q _{gs} | Gate-Source Charge | V _{DS} =30V, I _D =6A, V _{GS} =10V | | 2.2 | | nC |
| Q _{gd} | Gate-Drain Charge | | | 4 | | nC |
| DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS | | | | | | |
| I _s | Maximum Continuous Drain-Source Diode Forward Current | | | 1.5 | | A |
| V _{SD} | Diode Forward Voltage ^b | V _{GS} =0V, I _s =1.5A | | 0.81 | 1.3 | V |
| Notes | | | | | | |
| a.Surface Mounted on FR4 Board,t ≤ 10sec. | | | | | | |
| b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%. | | | | | | |
| c.Guaranteed by design, not subject to production testing. | | | | | | |
| d.Starting T _J =25°C,L=0.5mH,V _{DD} = 30V.(See Figure13) | | | | | | |

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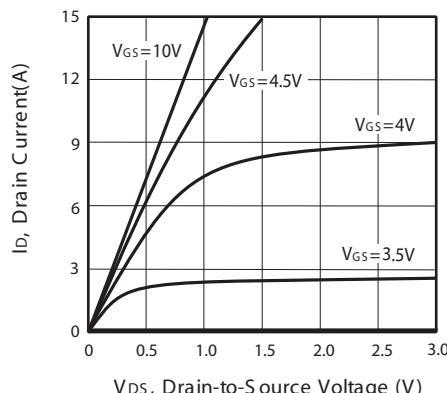


Figure 1. Output Characteristics

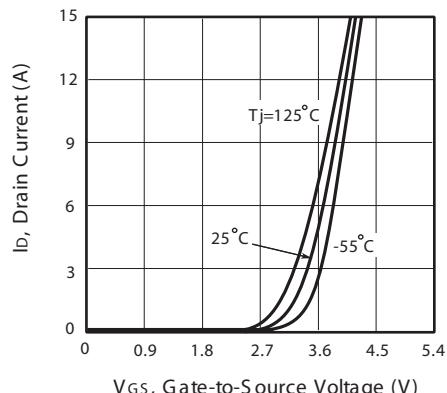


Figure 2. Transfer Characteristics

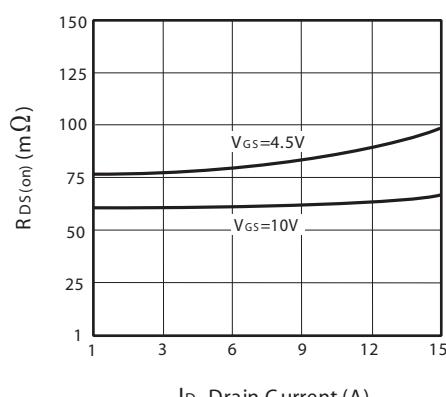


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

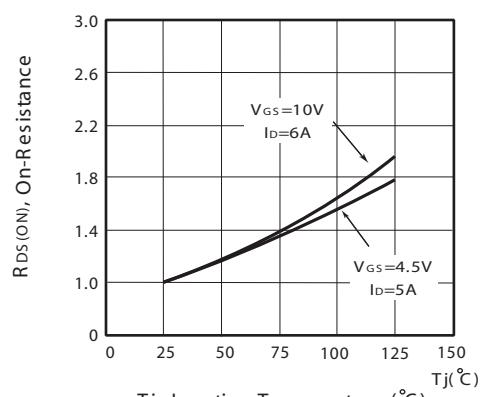


Figure 4. On-Resistance Variation with Drain Current and Temperature

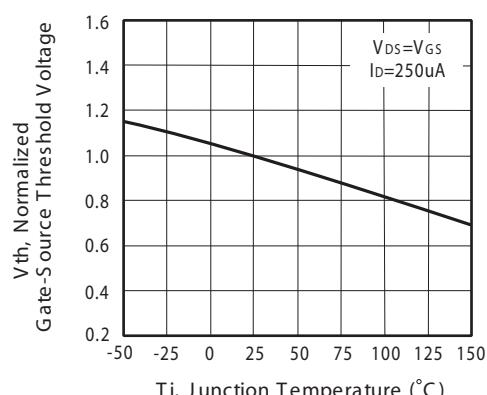


Figure 5. Gate Threshold Variation with Temperature

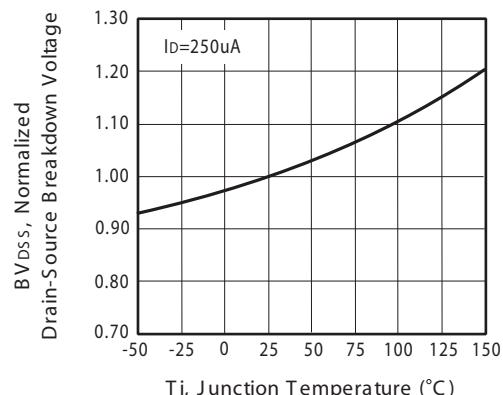


Figure 6. Breakdown Voltage Variation with Temperature

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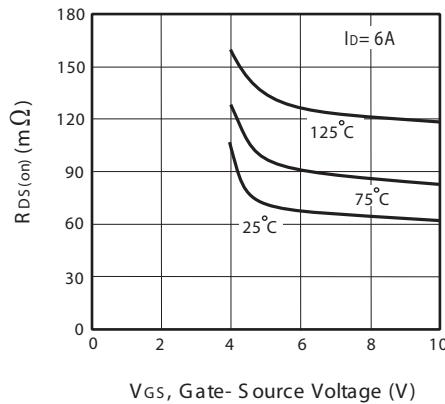


Figure 7. On-Resistance vs. Gate-Source Voltage

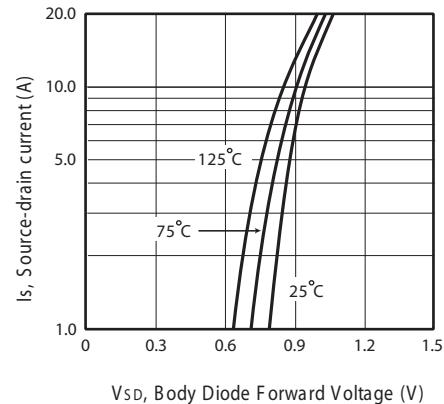


Figure 8. Body Diode Forward Voltage Variation with Source Current

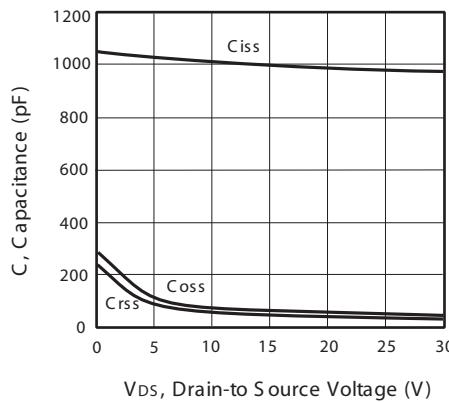


Figure 9. Capacitance

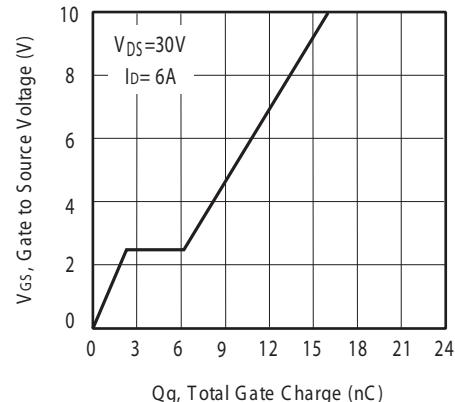


Figure 10. Gate Charge

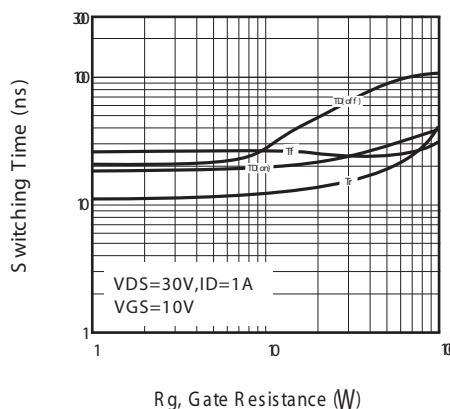


Figure 11. Switching characteristics

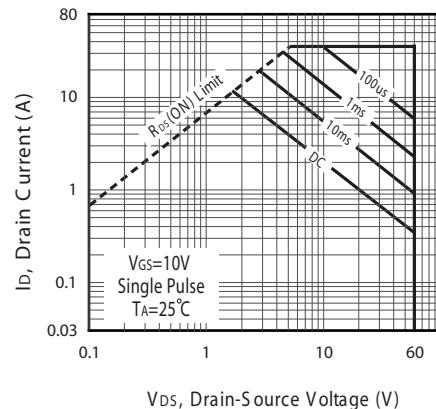
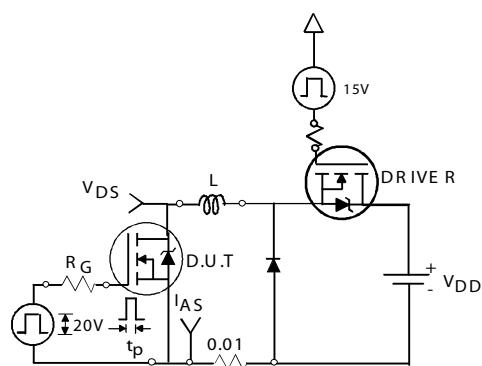


Figure 12. Maximum Safe Operating Area

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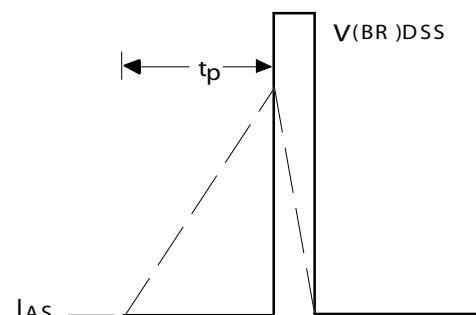
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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

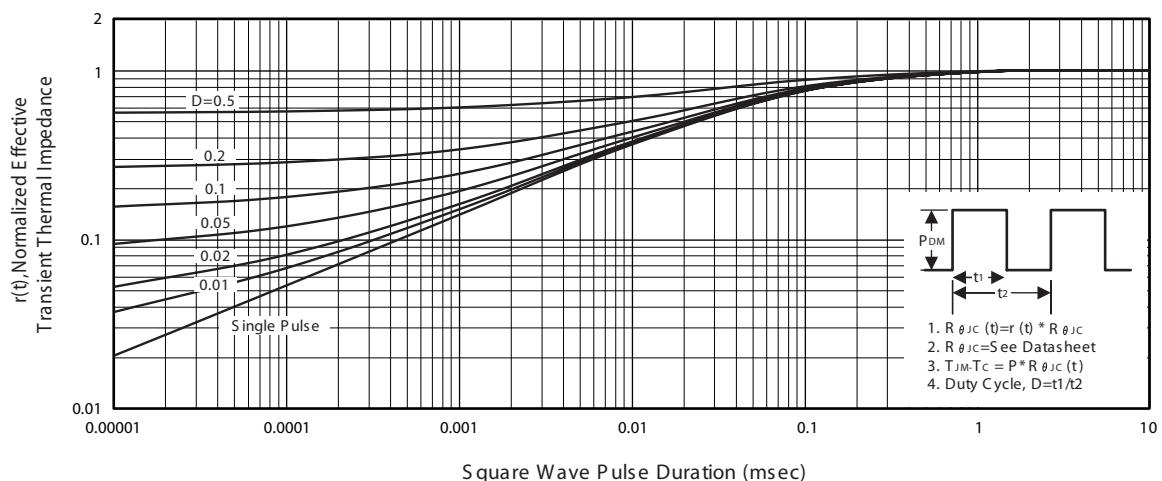


Figure 14. Normalized Thermal Transient Impedance Curve

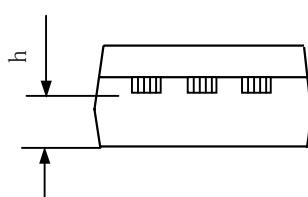
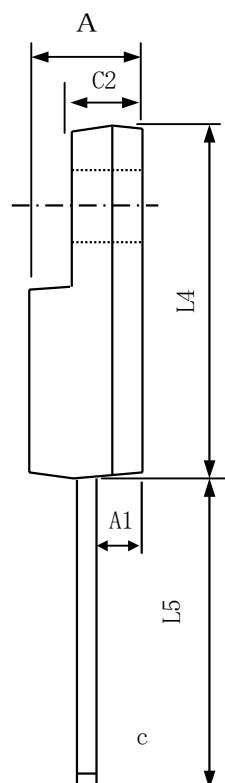
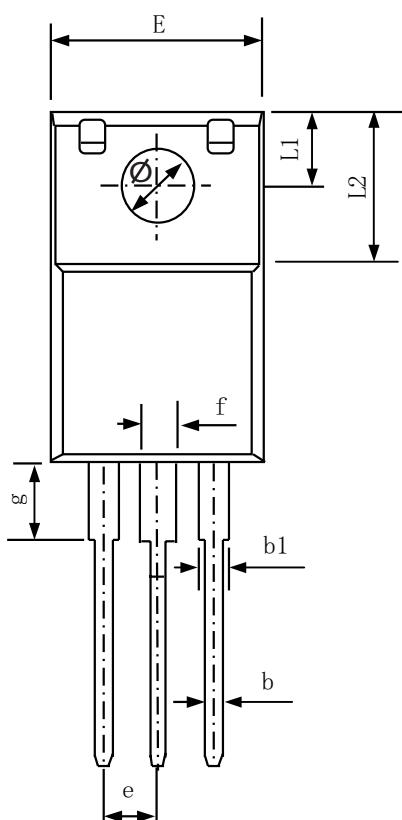
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PACKAGE OUTLINE DIMENSIONS

TO-220F



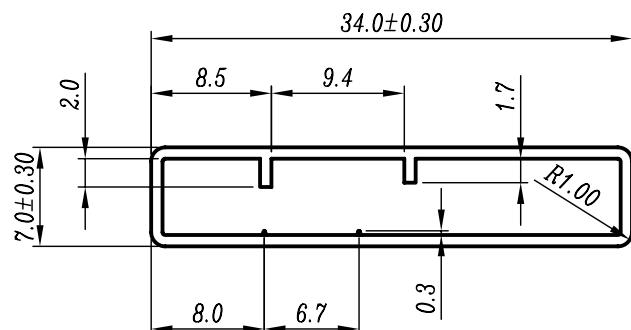
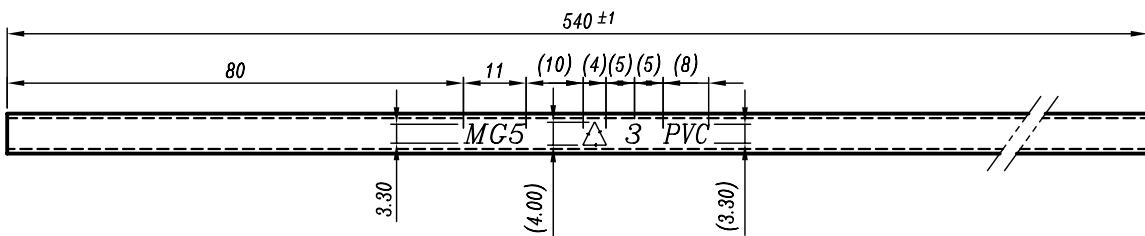
| SYMBOLS | MILLIMETERS | |
|---------|-------------|-------|
| | MIN | MAX |
| A | 4.20 | 4.80 |
| A1 | 1.95 | 2.85 |
| b | 0.56 | 1.05 |
| b1 | 0.90 | 1.50 |
| c | 0.55 | 0.80 |
| c2 | 2.50 | 3.10 |
| E | 9.70 | 10.30 |
| L1 | 3.20 | 3.80 |
| L2 | 6.90 | 7.50 |
| L4 | 15.60 | 16.40 |
| L5 | 13.50 | 14.50 |
| Ø | 3.20 | |
| e | 2.55 | |
| f | 1.30 | 1.90 |
| g | 3.40 | 3.80 |
| h | 2.10 | 2.70 |

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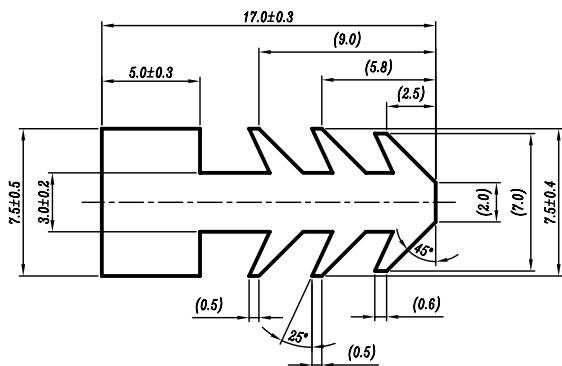
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TO-220F Tube



SCALE=2/1



$L = 8.0 \pm 0.5$

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